



SINGLE P-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
 - $11m\Omega$ @ $V_{GS} = -10V$
 - $17m\Omega$ @ $V_{GS} = -4.5V$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)
- "Green" Device (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOP-8L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208

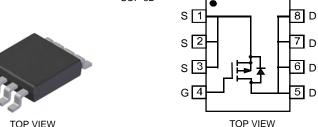
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- Marking Information: See Page 4
- Ordering Information: See Page 4

Internal Schematic

Weight: 0.072g (approximate)

SOP-8L



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V_{GSS}	±20	V
Drain Current (Note 1)	Steady State	T _A = 25°C T _A = 70°C	I _D	-13 -9.75	А
Pulsed Drain Current (Note 3)			I _{DM}	-45	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	P _D	2.5	W
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	50	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

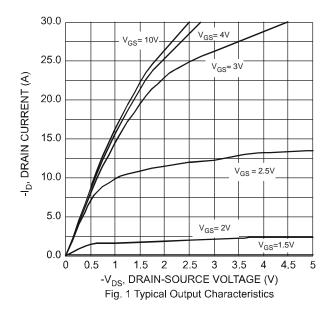
- 1. Device mounted on 2 oz. Copper pads on FR-4 PCB with $R_{\theta JA} = 50^{\circ}$ C/W.
- No purposefully added lead. 2.
- Pulse width ≤10μS, Duty Cycle ≤1%.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

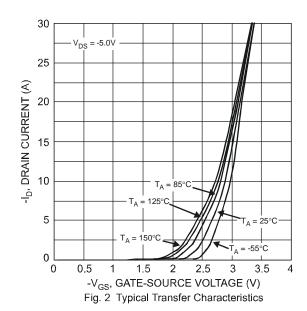


Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30		_	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_		-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	$V_{GS(th)}$	-1		-2	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Pro (our	_	9	11	mΩ	$V_{GS} = -10V, I_D = -13A$	
Static Diain-Source On-Nesistance	R _{DS} (ON)		14	17	1115.2	$V_{GS} = -4.5V, I_{D} = -10A$	
Forward Transconductance	g fs	_	15	_	S	$V_{DS} = -15V, I_{D} = -8A$	
Diode Forward Voltage (Note 5)	V_{SD}	-0.5	_	-1.1	V	$V_{GS} = 0V, I_{S} = -2.1A$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C _{iss}	_	2748	_	pF	.,	
Output Capacitance	Coss	_	357	_	pF	$V_{DS} = -20V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	356	l	pF	1 = 1.0101112	
Gate Resistance	R_{G}	_	2.0		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$ f = 1.0MHz	
SWITCHING CHARACTERISTICS	SWITCHING CHARACTERISTICS						
Total Gate Charge	Qg	_	30.0 60.4		nC	$V_{DS} = -10V$, $V_{GS} = -4.5V$, $I_{D} = -13A$ $V_{DS} = -10V$, $V_{GS} = -10V$, $I_{D} = -13A$	
Gate-Source Charge	Q _{gs}	_	7.2	_		V _{DS} = -10V, V _{GS} = -10V, I _D = -13A	
Gate-Drain Charge	Q _{gd}	_	16.4	_		$V_{DS} = -10V, V_{GS} = -10V, I_{D} = -13A$	
Turn-On Delay Time	t _{d(on)}	_	11.2	_			
Rise Time	t _r	_	12.4	_		$V_{DS} = -15V, V_{GS} = -10V,$	
Turn-Off Delay Time	t _{d(off)}	_	104.9	_	ns	$I_D = -1A$, $R_G = 6.0\Omega$	
Fall Time	t _f	_	61.7	_			

Notes: 5. Short duration pulse test used to minimize self-heating effect.







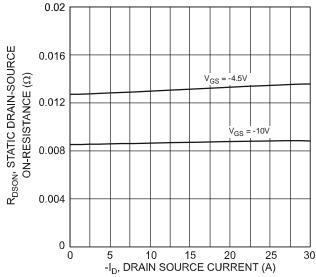


Fig. 3 On-Resistance vs. Drain Current & Gate Voltage

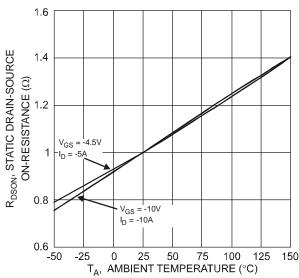


Fig. 5 Static Drain-Source On-Resistance vs. Ambient Temperature

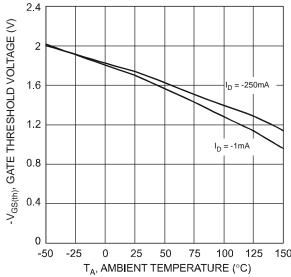


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

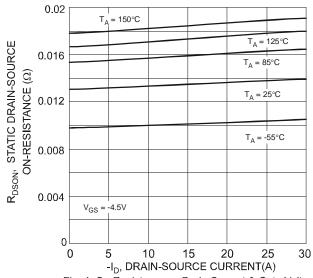
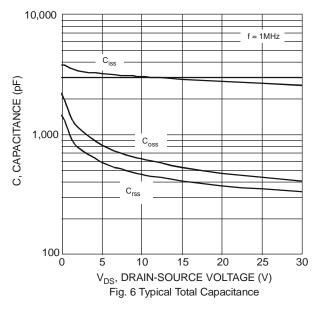


Fig. 4 On-Resistance vs.Drain Current & Gate Voltage



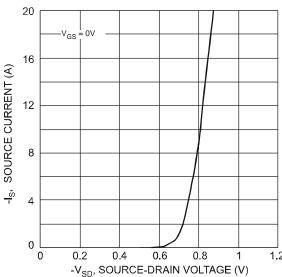


Fig. 8 Forward Drain Current vs. Source-Drain Voltage



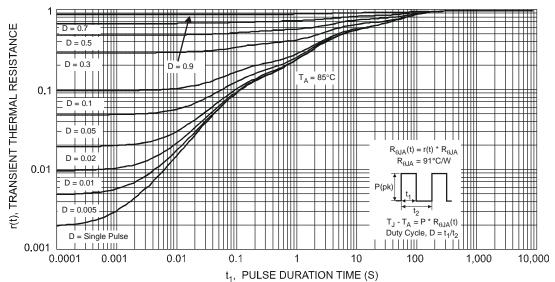


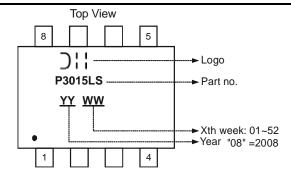
Fig. 9 Transient Thermal Resistance

Ordering Information (Note 6)

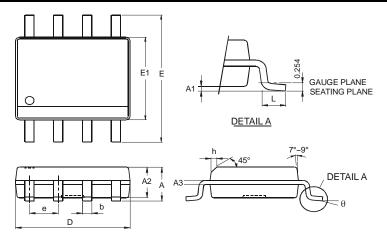
Part Number	Case	Packaging
DMP3015LSS-13	SOP-8L	2500/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



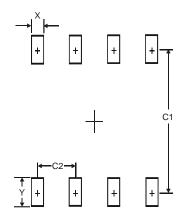
Package Outline Dimensions



SOP-8L				
Dim	Min	Max		
Α		1.75		
A1	0.08	0.25		
A2	1.30	1.50		
А3	0.20 Typ.			
b	0.3	0.5		
D	4.80	5.30		
E	5.79	6.20		
E1	3.70	4.10		
е	1.27 Typ.			
h	_	0.35		
L	0.38	1.27		
θ	0°	8°		
All Di	All Dimensions in mm			



Suggested Pad Layout



Dimensions	Value (in mm)
X	0.60
Υ	1.55
C1	5.4
C2	1.27

IMPORTANT NOTICE

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